



MATURATION OF PROMISING CFRP-LATTICE AND SANDWICH TECHNOLOGIES FOR REPRESENTATIVE FUTURE LAUNCHER INTERSTAGE AND INTERTANK STRUCTURES

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MT AEROSPACE - WHO WE ARE







Matured over decades to a Tier 1 Aerospace Supplier



ARIANE 6

An OHB Company

- MT Aerospace holds about 10% workshare in Ariane 6
- Design definition authority for metallic aero structures
- Design and development responsibility for core manufacturing processes/facilities





A6 INTERTANK STRUCTURE

- Two metallic A6 intertank structures (ITS) are manufactured at MT Aerospace (main and upper stage)
- The upper stage dry mass is one important parameter for the payload performance
 - 1 kg upper stage mass decrease means 1 kg payload increase
 - 1 kg main stage mass decrease means only about 0.3 kg payload increase
- Upper stage dry mass decrease is main focus at A6 optimization
- Development of complete CFRP upper stage currently done by MT Aerospace and Ariane Group Bremen in ESA FLPP program
- Main focus in this presentation: development of CRFP intertank structure



A6 UPPER STAGE INTERTANK STRUCTURE (U-ITS)

- Aim of introducing CFRP material into the upper stage is to reduce the upper stage mass considerably and to reduce the costs by highly automated manufacturing
- For unpressurized structures two technologies present themselves
 - Lattice technology
 - Sandwich technology
- Depending on the boundary conditions each technology has advantages and disadvantages for launcher application
 - For an A6 intertank structure, where interfaces to the metallic parts are necessary both a lattice and sandwich structure is a possibility
 - For a complete CRFP upper stage, where sandwich technology is already present for the tanks a sandwich ITS makes more sense (no additional IF)



Envisioned Metallic A6 Upper Metallic A6 Upper Stage with CFRP Stage with CFRP **CFRP** Upper Lattice ITS Sandwich ITS Stage Sandwich U-ITS Lattice U-ITS

TARGET APPLICATION – U-ITS REQUIREMENTS



- To compare both technologies fair, the same target application (A6 upper stage - U-ITS - h ≈ 3.0 m, d ≈ 5.4 m) is chosen
- Based on the same requirements the target application design is defined and verified by analysis for both technologies
- To improve the technology and manufacturing readiness level (TRL and MRL) coupon samples, test elements and breadboards are designed, manufactured and tested
 - The design of the test elements and breadboards are based on the target application design
 - Boundary conditions and loading should be similar to the target application



Target Application: Metallic A6 Upper Stage



Development and Verification Approach

TARGET APPLICATION - U-ITS REQUIREMENTS

- Following main requirements must be met:
 - Transfer of high general flux loads (tension/compression)
 - Connections to metallic LH2 and LOX tank and composite interface structure (IFS)
 - Withstanding of high local loads due to LOX tank suspension
 - Cut outs for local interfaces with high/medium and low loads for equipment and access
 - Withstand high thermal gradients
 - Provide connection points for equipment e.g. avionic
 - Withstand low inner pressure for cavity flushing between tanks
 - Overflux within given boundaries
 - A highly automated manufacturing process with AFP
 - Considerable mass decrease and reduced costs compared to metallic version







DEVELOPMENT AND VERIFICATION APPROACH

Design Reference

- · Loading and boundary conditions
- Performance
- Mass
- Costs

Lattice Breadbord test in 2020 Sandwich Panel test in winter 2023

Tested under representative compressive loading

- Mechanical justification
- Verification of manufacturing quality
- Improve of numerical methods
- Real field data concerning costs $\emptyset \approx 0.9 \text{ m}$
- Lattice TRL 4, Sandwich TRL 4-5





 - U-ITS

One panel of

full scale

cylinder



Sub-scale Breadboard Tests at RT

(theoretical)

Understanding of singular effect

- Tested under representative loading
- Calibration of FE models
- TRL 3





Test Elements at RT

Coupon Samples at 77K/RT/80°C

Characterization of CFRP and core materials

- Same manufacturing process as for structural parts used
- Temperature impact investigated





TARGET APPLICATION DESIGN - MAIN INTERFACES



- The intertank structure connects the two propellant tanks LH2 and LOX and provides a connection to the interface structure (IFS, main stage)
- All interface partners are metallic components
 - due to present extreme temperatures (20K [upper IF to LH2 tank] 353K [lower IF to IFS]) the thermal
 mismatch is a topic to be solved
- High compression/tension flux loads must be transferred over the main IF
- At the interface to the LOX tank an additional radial deformation is present, which occurs due to the deformation of the tank under pressure

Lattice Technology

 Transition from lattice with skin to pure monolithic zone



Sandwich Technology

 Reinforced monolithic zones defined for all main interfaces





TARGET APPLICATION DESIGN - CUT OUTS



- Cut outs and local interfaces are necessary for equipment mounting and access to the tanks/equipment
- Depending on the size of the cut outs and magnitude of the local loads different design solutions are present

Lattice Technology

 Cut outs must be adapted to typical lattice geometry (yellow metallic cut out geometry, purple lattice cut out geometry)



Sandwich Technology

- Cut outs have identical geometry as for metallic design
- Monolithic regions around cut outs to simplify mounting



TARGET APPLICATION DESIGN - FAR AND NEAR FIELD



- General flux loads lead to homogenous load over the cylinder
- Due to cut outs, local loads and the LOX tank connection the loading varies over the circumference and in axial direction
- To save mass a near (high loaded area) and far field (lower loaded area) approach is chosen

Lattice Technology

- Near field compared to far field
 - Increased rib height
 - Steeper helical rib angle
 - Skin locally reinforced

Sandwich Technology

- Near field compared to far field
 - Honeycomb core with smaller cell width and higher density chosen
 - Honeycomb stabilized with core filler
 - Facesheets locally reinforced



Sandwich U-ITS blue: near field brown: far field

TARGET APPLICATION - STRUCTURAL JUSTIFICATION



- For the strength and stability justification of the U-ITS a geometrical and material nonlinear, implicit analysis with ABAQUS as solver is chosen
- Global and local models (GFEM/DFEM) are used

- Applied loads and boundary conditions
 - Global flux (compression/tension and mounting)
 - Temperature field (hot and cold load case)
 - Adjacent structures (LOX & LH2 and IFS)
 - Radial deformation
 - LOX- and VINCI/VITF-loads
 - Axial force
 - Lateral force
 - Bending moment
 - ightarrow Can rotate freely around axis of flight direction
 - Local I/F loads (AVSS, TFB, Cable Duct etc.)



TARGET APPLICATION - MANUFACTURING PROCESS

- General
 - Fully automated deposition
 - Digital integration from design and analysis to manufacturing
- Sandwich technology
 - Co-cured the sandwich structure is realized in a single curing step
- Lattice technology
 - Original manufacturing method for the lattice structure is based on a technology developed by ATG Europe B. V. (manual process)
 - Process is adapted for automated fiber placement process





LATTICE - TEST ELEMENTS

- Compression test on flat knot samples
 - Samples with skin
 - Samples without skin
 - Main interface zone
- Based on breadboard design
- Influence on manufacturing method investigated
 - Manual
 - AFP process
- Comparison between FE analysis and test results performed
 - To validate FE approach used for the sub and full scale analysis









Samples manufactured by AFP process showed a significant higher strength

Top: AFP manufacturing Bottom left: Main IF sample Bottom right: Knot w/o skin sample

LATTICE - TEST BREADBOARD



- Design
 - target application geometry adapted to the dimensions of the breadboard (Ø ≈ 0.9m)
 - maintaining the structural characteristics representative in comparison to the full scale design
- Manufacturing
 - A manual manufacturing has been used for the test breadboard (TBB)
 - For a later serial production a AFP process, proven by the knot samples, is foreseen
- Test Prediction
 - Based on as build geometry and knot sample results
 - Nonlinear analysis using ABAQUS
 - To understand the global and local behavior a solid element based submodel was embedded in a global shell model



Subscale lattice structure (TBB)



LATTICE - TEST BREADBOARD



Test

- In January 2020 a compression test was successfully performed in Augsburg
- Failure occurred at a maximum load of ~2800 kN
- To understand the failure mechanics different measurement systems were used:
 - Optical measurement (ARAMIS) from four sides
 - Radial and axial displacement transducers
 - Strain gauges
- Test Evaluation
 - A fracture directly under the knots occurred mid cylinder
 - The seen failure mode was in line with the prediction
 - Failure procedure:
 - failure occurred locally at a single knot probably following a local skin buckling
 - after the fracture of a single knot, the local failure spread out to the other knots following a load transfer



Lattice structure TBB after the test showing a circulating fracture



Fracture pattern of the lattice structure TBB after the test

LATTICE - TEST BREADBOARD



- Test Correlation
 - Based on the measurements, implementation of the inhomogeneous load introduction in the FE analysis
 - Increased deformation near the circumferential position of 0°
 - Inhomogeneous flux loading (highest flux loads near 0°)
 - Embedding detailed solid submodel into 360° shell model at 0° position
 - Failure occurs at the load level observed during the test
 - Strength failure directly under a knot mid cylinder → correlates very well with the test
 - Deviation of the global failure load and the one observed in the test within the given tolerance

- ➔ Successful subscale test
- ➔ Prove of analysis methods
- → With this knowledge a significant mass decrease compared to A6 upper stage ITS is possible





Deformation of the FE implementation at the load level coupled to the failure in the test; detailed submodel showing contour plot

SANDWICH - TEST ELEMENTS

- Compression/tensile test on flat samples
 - Cut out
 - LOX tank attachment
 - Main interface
- Based on target application design
- Manufacturing quality investigated
- Comparison between FE analysis and test results performed
 - → To validate FE approach used for breadboard and full scale analysis



Top: Cut Out Sample Right: LOX introduction IF sample Left: Mail IF sample









SANDWICH - TEST BREADBOARD

- Design
 - One full scale panel of target application ($\emptyset \approx 5.4 \text{ m}$, h $\approx 3 \text{ m}$, b $\approx 2 \text{ m}$)
 - All important features included
 - Main interfaces
 - Cut outs and local interfaces
 - Far field and near field including stiffening elements
- Manufacturing
 - Same automated fiber placement process as planned for serial production
 - Co-cured the sandwich structure is realized in a single curing step
- Test Predition and Test
 - Including general compression fluxes
 - Nonlinear analysis using ABAQUS based on as built geometry
 - Test planned in Q3/4 2023



Metallic A6-UITS Cylinder Panel next to Sandwich Manufacturing Breadboard (MBB)





LATTICE VS SANDWICH TECHNOLOGY



- Mass:
 - CFRP solution is developed in order to aim for 25% mass reduction compared to corresponding metallic baseline
 - No significant mass difference between the two CFRP technologies can be seen
 - Limitations: Lattice mass only achievable if a significant rib height can be realized (needed for $\emptyset \approx 5.4$ m)
 - Significant mass impact due to local interfaces for both concepts
- Costs:
 - Cost performance of CFRP solution can be better than corresponding metallic baseline
 - Using same production set-up Lattice technology is significant more expansive than Sandwich technology
 - By investing in more machining (parallel production higher NRCs) the Lattice RC can be reduced to a comparable range
 - Significant cost and mass impact due to segmentation for both technologies
 - Material handling for only one material (Lattice technology) saves costs
- Technology readiness level (TRL) at MT Aerospace:
 - Lattice: TRL 4 (subscale barrel test breadboard)
 - Sandwich: TRL 4-5 (full scale panel test breadboard)

LATTICE VS SANDWICH TECHNOLOGY



Included design features:

	Design		Test Breadboard	
	Lattice	Sandwich	Lattice	Sandwich
Main IF				
Cylindrical IF (LH2 tank and IFS)	х	х	х	х
Conical IF (LOX tank)	х	х	-	х
Cut outs and local interfaces	х	х	-	х
Segmentation	-	x	-	x
Far and near field	х	х	-	х

Open Point:

- Segmentation for Lattice technology or integral solution for Sandwich technology
- Connection between grid and skin for Lattice technology in combination with AFP
- ➔ Both technologies have advantages and disadvantages depending on the application and requirements. Therefore, it is beneficial to have both technologies in the portfolio. Depending on the requirements, the most appropriate technology must be chosen. To apply the technologies on the U-ITS a certain development is still necessary.

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